

# NCL30085FLYGEVB, NCL30088FLYGEVB



ON Semiconductor®

[www.onsemi.com](http://www.onsemi.com)

## 10 W High Power Factor Isolated LED Driver Evaluation Board User's Manual

### EVAL BOARD USER'S MANUAL

#### Overview

This manual covers the specification, theory of operation, testing and construction of the NCL30085/88FLYGEVB evaluation board. The NCL30085/88 board demonstrates a 10 W high PF isolated flyback LED driver in a typical A19 outline. The 2 evaluation boards are nearly identical in construction except for the controller and Vcc bulk capacitor. The NCL30088 controller is a non-dimming version while the NCL30085 supports 3 levels of step dimming.

#### Key Features

As illustrated, the key features of this evaluation board include:

- Wide Mains
- Low THD across Line and Load
- High Power Factor across Wide Line and Load
- Integrated Auto Recovery Fault Protection (can be latched by Choice A Version)
  - ◆ Programmable Over Temperature Thermal Foldback (NTC mounted on PCB)
  - ◆ Cycle by Cycle Current Limiting
  - ◆ Open LED and Shorted Output Protection

Table 1. SPECIFICATIONS

| Parameter                                | Value         | Comment   |
|--|---------------|-----------|
| Input voltage (Class 2 Input, no ground) | 90 – 265 V ac |           |
| Line Frequency                           | 50 Hz / 60 Hz |           |
| Power Factor (100% Load)                 | 0.9           | Min       |
| THD (100% Load)                          | 20%           | Max       |
| Class 2 Output Mains Isolated            |               |           |
| Output Voltage Range                     | 14 – 28 V dc  |           |
| Output Current                           | 350 mA dc     | ±2%       |
| Efficiency                               | 85%           | Typical   |
| Start Up Time                            | < 500 msec    | Typical   |
| EMI (conducted)                          | Class B       | FCC/CISPR |

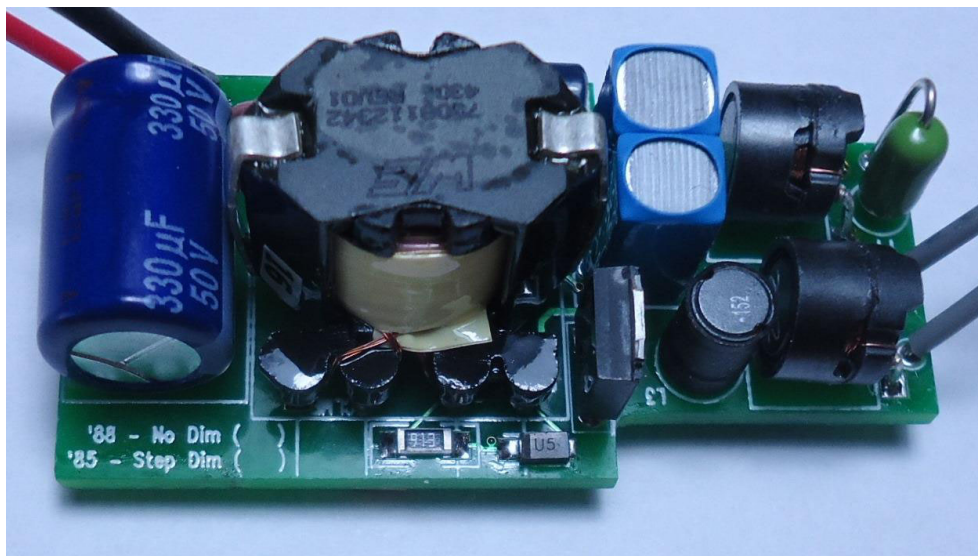


Figure 1. Evaluation Board Picture (Top View)

## THEORY OF OPERATION

### Power Stage

The power stage for the evaluation boards is an isolated flyback. The controller has a built in control algorithm that is specific to the flyback transfer function. Specifically:

$$\frac{V_{out}}{V_{in}} = \frac{Duty}{(1 - Duty)}$$

This is applicable to flyback, buck boost, and SEPIC converters. The control is very similar to the control of the NCL30080–83 with the addition of a power factor correction control loop. The controller has a built in hardware algorithm that relates the output current to a reference on the primary side.

$$I_{out} = \frac{V_{ref} \times N_{ps}}{2 \times R_{sense}}$$

$$N_{ps} = \frac{N_{pri}}{N_{sec}}$$

Where  $N_{pri}$  = Primary Turns and  $N_{sec}$  = Secondary Turns  
We can now find  $R_{sense}$  for a given output current.

$$R_{sense} = \frac{V_{ref} \times N_{ps}}{2 \times I_{out}}$$

### Line Feedforward

$R3$  sets the line feedforward which compensates for power stage delay times by reducing the current threshold as the line voltage increases.  $R3$  is also used by the shorted pin detection. At start up the controller generates a current from the CS pin to check for a short to ground. If  $R3$  is zero, the current sense resistor is too low a value and the controller will not start because it will detect a shorted pin. So  $R3$  is required to make the controller operate properly.

### Voltage Sense

The voltage sense pin has several functions:

1. Basis for the reference of the PFC control loop
2. Line Range detection

The reference scaling is automatically controller inside the controller. While the voltage on  $V_s$  is not critical for the PFC loop control it is important for range detection. Generally the voltage on  $V_s$  should be 3.5 V peak at the highest input voltage of interest. The voltage on  $V_s$  determines which valley the power stage will operate at in full load. At low line and maximum load, the power stage operates in the first valley (standard CrM operation). At the higher line range, the power stage moves to the second valley to lower the switching frequency while retaining the advantage of CrM soft switching.

### Auxiliary Winding

The auxiliary winding has 3 functions:

1. CrM timing
2.  $V_{cc}$  Power
3. Output voltage sense

#### CrM Timing

In the off time, the voltage on the transformer/inductor forward biases  $D_{out}$  and  $D_9$ . When the current in the magnetic has reached zero, the voltage collapses to zero. This voltage collapse triggers a comparator on the ZCD pin to start a new switching cycle. The ZCD pin also counts rings on the auxiliary winding for higher order valley operation. A failure of the ZCD pin to reach a certain threshold also indicates a shorted output condition fault.

#### $V_{cc}$ Power

The forward biases  $D_9$  to provide power for the controller. This arrangement is called a “bootstrap”. Initially the  $C_{vcc}$  is charged through  $R4$  and  $R5$ . When the voltage on  $C_{vcc}$  reaches the startup threshold, the controller starts switching and providing power to the output circuit and the  $C_{vcc}$ .  $C_{vcc}$  discharges as the controller draws current. As the output voltage rises, the auxiliary winding starts to provide all the power to the controller. Ideally, this happens before  $C_{vcc}$  discharges to the undervoltage threshold where the controller stops operating to allow  $C_{vcc}$  to recharge once again. The size of the output capacitor will have a large effect on the rise of the output voltage. Since the LED driver is a current source, the rise of output voltage is directly dependent on the size of the output capacitor.

There are tradeoffs in the selection of  $C_{out}$  and  $C_{vcc}$ . A low output ripple will require a large  $C_{out}$  value. This requires that  $C_{vcc}$  be large enough to support  $V_{cc}$  power to the controller while  $C_{out}$  is charging up. A large value of  $C_{vcc}$  requires that  $R4$  and  $R5$  be lower in value to allow a fast enough startup time. Smaller values of  $R4$  and  $R5$  have higher static power dissipation which lowers efficiency of the driver.

#### Output Voltage Sense

The auxiliary winding voltage is proportional to the output voltage by the turns ratio of the output winding and the auxiliary winding. The controller has an overvoltage limit on the  $V_{cc}$  pin at about 26 V minimum. Above that threshold, the controller will stop operation and enter a fault mode for overvoltage. This is the open load protection.

In cases where the output has a lot of ripple current and the LED has high dynamic resistance, the peak output voltage can be much higher than the average output voltage. The auxiliary winding will charge the  $C_{vcc}$  to the peak of the output voltage which may trigger the OVP sooner than expected.

## SD Pin

The SD pin is a multifunction protection input.

1. Thermal Foldback Protection
2. Programmable OVP

### *Thermal Foldback*

The OCV of the SD pin is 1.35 V. There is an internal current source connected to the SD pin even though the voltage is soft clamped to 1.35 V. Output current is reduced when the voltage on the SD pin drops below 1 V. Placing an NTC on the SD pin will allow the designer to choose the level of protection from over temperature. Below 0.5 volts on SD, the controller stops. Series or parallel resistors on the NTC can shape the foldback curve. An online EXCEL<sup>®</sup> based design tool is available at onsemi.com which provides support to select the appropriate value.

### *Programmable OVP*

While the SD pin has a current source for the OTP, it can be overcome raising the voltage on the SD pin. At about 2.75 V, the SD pin detects an OVP and shuts down the controller. Typically, a zener to Vcc is used for this. In this way, the designer can set the OVP to a lower value than the OVP threshold built into the Vcc pin.

## Step Dimming

Step dimming is only available on the NCL30085FLYGEVB. Cbulk is added to keep Vcc active for brief AC power interruptions. There are 3 dimming current levels for the NCL30085FLYGEVB after the driver is powered on.

ON 100%

1. 70%
2. 25%
3. 4%

AC power interruption is detected on Vs when the voltage on Vs is below 1 V for 30 ms. Internally, the controller steps the internal Vref down to the next dimming level. After the lowest level, Vref cycles back to 100%. Issues with step dimming can be traced to Vcc dropping below the undervoltage cutoff before the input has been detected as off for 35 ms minimum.. This is caused by one of the following:

1. Operating Vcc too low (related to Vled)
2. Cbulk too small
3. Cout too large and discharges too much during the AC interruption. This is particularly seen at the lowest dim levels where the output current cannot recharge Cout fast enough.

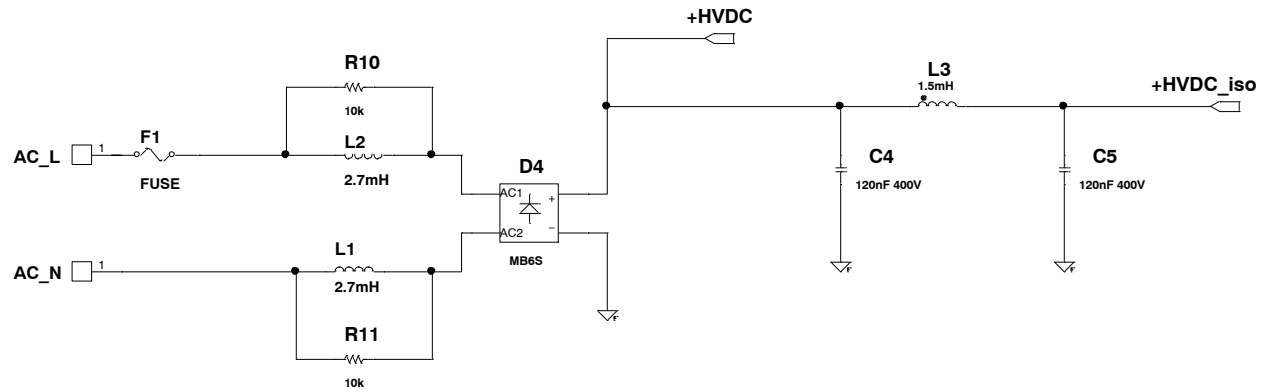
For a more detailed discussion of step dimming, refer to DN05065/D.

## Circuit Modifications

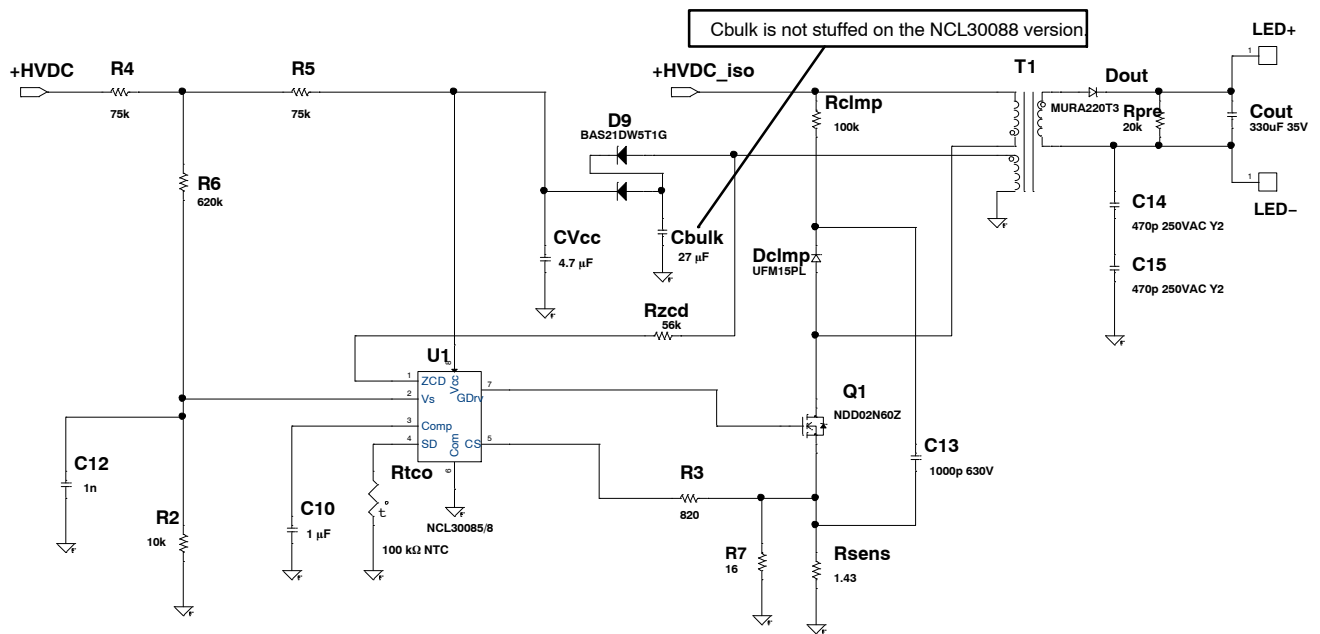
### *Output Current*

The output current is set by the value of Rsense as shown above. It's possible to adjust easily change the output current within  $\pm 10\%$  of the set value by changing R7. Further adjustments may require changes to the transformer depending on the LED  $V_F$  and current.

## SCHEMATIC



### Figure 2. Input Circuit



### Figure 3. Main Schematic

# NCL30088FLYGEVB

## BILL OF MATERIAL

Table 2. BILL OF MATERIAL\*

| Qty | Reference | Part               | Manufacturer     | Mfr_PN             | PCB Footprint          | Substitution Allowed |
|-----|-----------|--------------------|------------------|--------------------|------------------------|----------------------|
| 1   | Cvcc      | 4.7 $\mu$ F        | AVX              | TAJB475M035RNJ     | 1210                   | Yes                  |
| 1   | Cbulk     | 27 $\mu$ F         | Panasonic        | EEU-FC1E270        | CAP-ALEL-4X11-HOR      | Yes                  |
| 1   | Cout      | 330 $\mu$ F 35 V   | Nichicon         | UHE1V331MPD        | CAP-ALEL-10X16-HOR     | Yes                  |
| 2   | C4, C5    | 120 nF 400 V       | Epcos            | B32559C6124+***    | CAP-BOX-LS5-5M0X7M2    | Yes                  |
| 1   | C10       | 1 $\mu$ F          | Taiyo Yuden      | GMK107AB7105KAHT   | 603                    | Yes                  |
| 1   | C12       | 1 n                | Kemet            | C0402C102K3GACTU   | 402                    | Yes                  |
| 1   | C13       | 1000 p 630 V       | Kemet            | C0805C102KBRCTU    | 805                    | Yes                  |
| 2   | C14, C15  | 470 p 250 VAC Y2   | Murata           | GA342QR7GF471KW01L | 1808                   | Yes                  |
| 1   | Dclmp     | UFM15PL            | MCC              | UFM15PL            | SOD123FL               | Yes                  |
| 1   | Dout      | MURA220T3          | ON Semiconductor | MURA220T3          | SMA                    | No                   |
| 1   | D4        | MB6S               | MCC              | MB6S               | MB6S                   | Yes                  |
| 1   | D9        | BAS21DW5T1G        | ON Semiconductor | BAS21DW5T1G        | SC-88A                 | No                   |
| 1   | F1        | FUSE               | Littelfuse       | 0263.500WRT1L      | FUSE-HAIRPIN-LS250     | Yes                  |
| 2   | L1, L2    | 2.7 mH             | Bourns           | RL875S-272K        | Drum_Core_Hor_LS5_875S | Yes                  |
| 1   | L3        | 1.5 mH             | Würth            | 7447462152         | IND-UPRIGHT-LS25       | Yes                  |
| 1   | Q1        | NDD02N60Z          | ON Semiconductor | NDD02N60Z          | IPAK                   | No                   |
| 1   | Rclmp     | 100 k              | Yaego            | RC1206FR-07100KL   | 1206                   | Yes                  |
| 1   | Rpre      | 20 k               | Yaego            | RC0603FR-0720KL    | 603                    | Yes                  |
| 1   | Rsens     | 1.43               | Yaego            | RC1206FR-071R43L   | 1206                   | Yes                  |
| 1   | Rtco      | 100 k $\Omega$ NTC | Epcos            | B57331V2104J60     | 603                    | Yes                  |
| 1   | Rzcd      | 56k                | Yaego            | RC0805FR-0756KL    | 805                    | Yes                  |
| 1   | R2        | 10k                | Yaego            | RC0402FR-0710KL    | 402                    | Yes                  |
| 1   | R3        | 820                | Yaego            | RC0402FR-07820RL   | 402                    | Yes                  |
| 2   | R4, R5    | 75 k               | Yaego            | RC1206FR-0775KL    | 1206                   | Yes                  |
| 1   | R6        | 620 k              | Yaego            | RC1206FR-07620KL   | 1206                   | Yes                  |
| 1   | R7        | 16                 | Yaego            | RT0402FRE0716RL    | 603                    | Yes                  |
| 2   | R10, R11  | 10 k               | Yaego            | RC0805JR-0710KL    | 805                    | Yes                  |
| 1   | T1        | XFRM_LINEAR        | Würth            | 7508112342         | RM6-4P-TH-FLYLEADS     | Yes                  |
| 1   | U1        | NCL30085B          | ON Semiconductor | NCL30085B          | SO8                    | No                   |
|     |           | NCL30088B          |                  | NCL30088B          |                        |                      |
| 6"  | W1        | Wire, Red, 24AWG   | McMaster Carr    | 7587K922           | UL1569                 | Yes                  |
| 6"  | W2        | Wire, Blk, 24AWG   | McMaster Carr    | 7587K921           | UL1569                 | Yes                  |
| 12" | W3, W4    | Wire, Wht, 24AWG   | McMaster Carr    | 7587K924           | UL1569                 | Yes                  |

\*All Components to comply with RoHS 2002/95/EC

# NCL30088FLYGEVB

## GERBER VIEWS

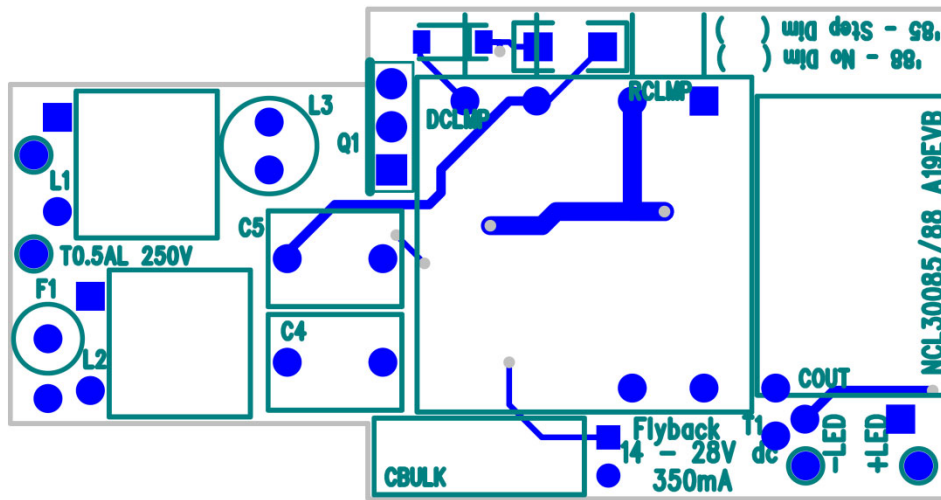


Figure 4. Top Side PCB

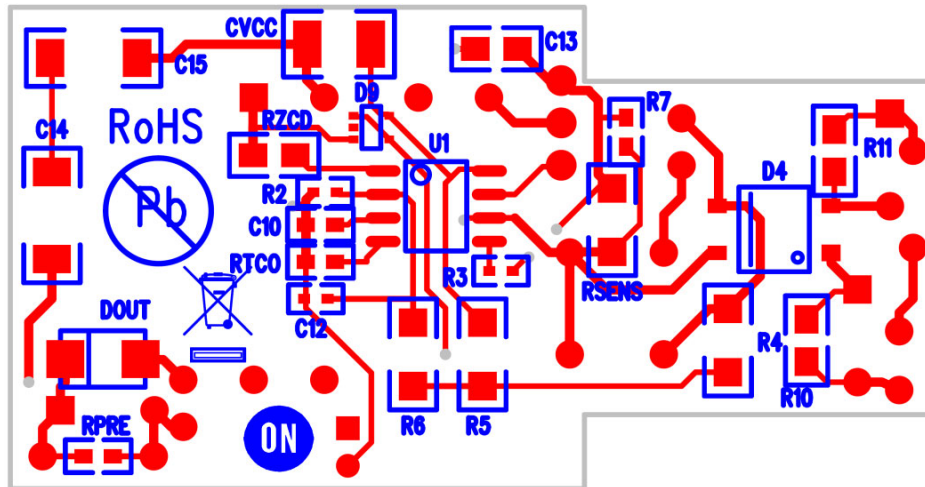


Figure 5. Bottom Side PCB

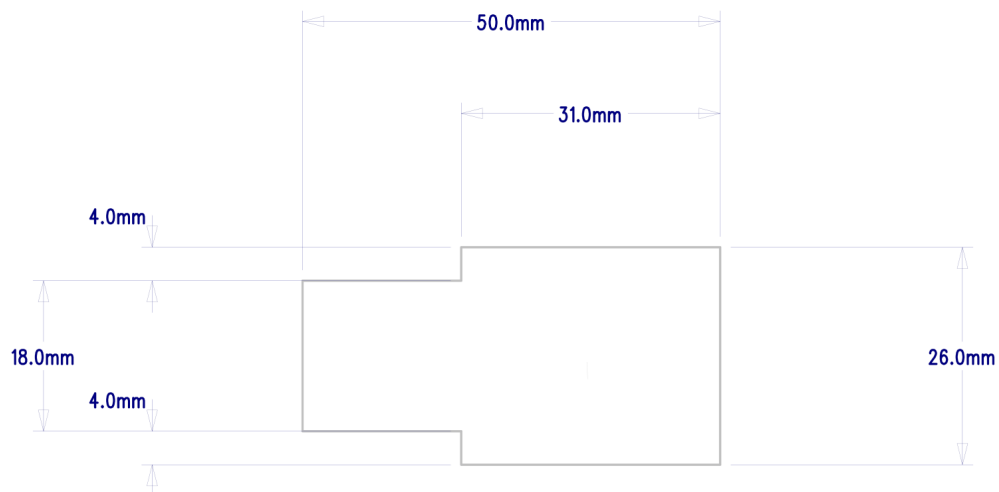
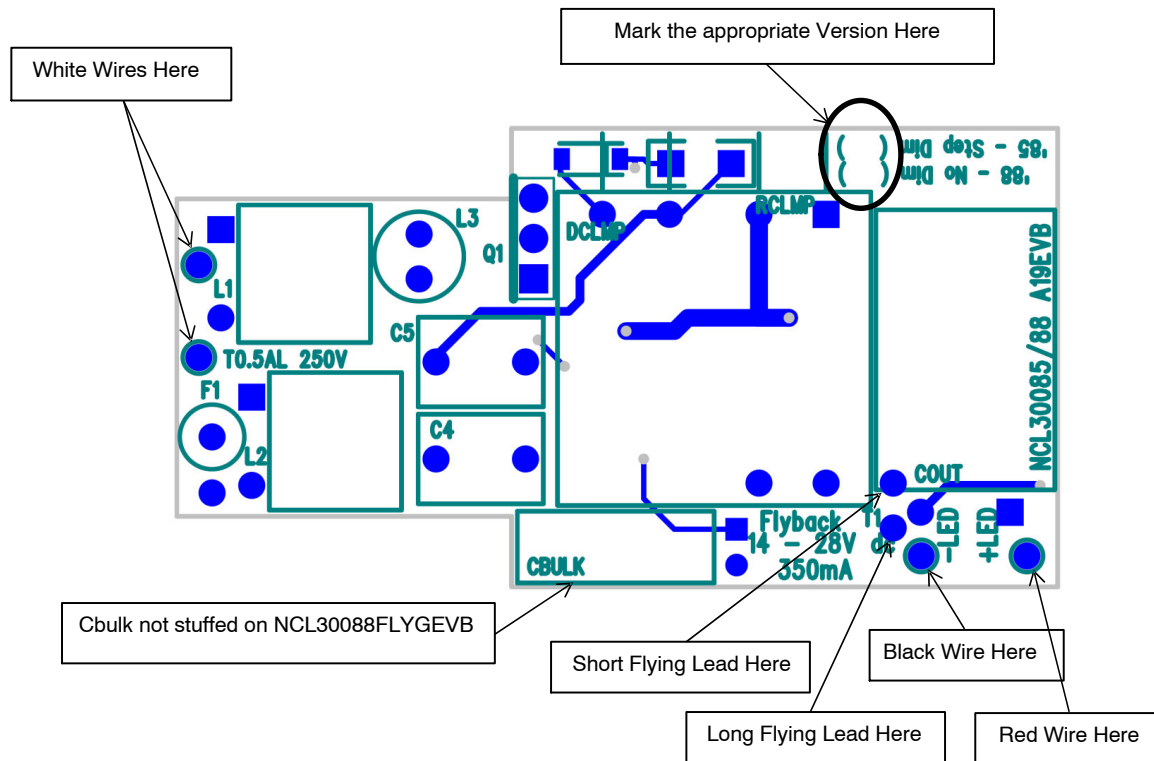


Figure 6. PCB Outline

# NCL30088FLYGEVB



1. Trim Transformer flying leads for minimum length.
2. Strip and tin lead wires to  $6'' \pm 0.5''$  4 Places.

**Figure 7. Assembly Notes**

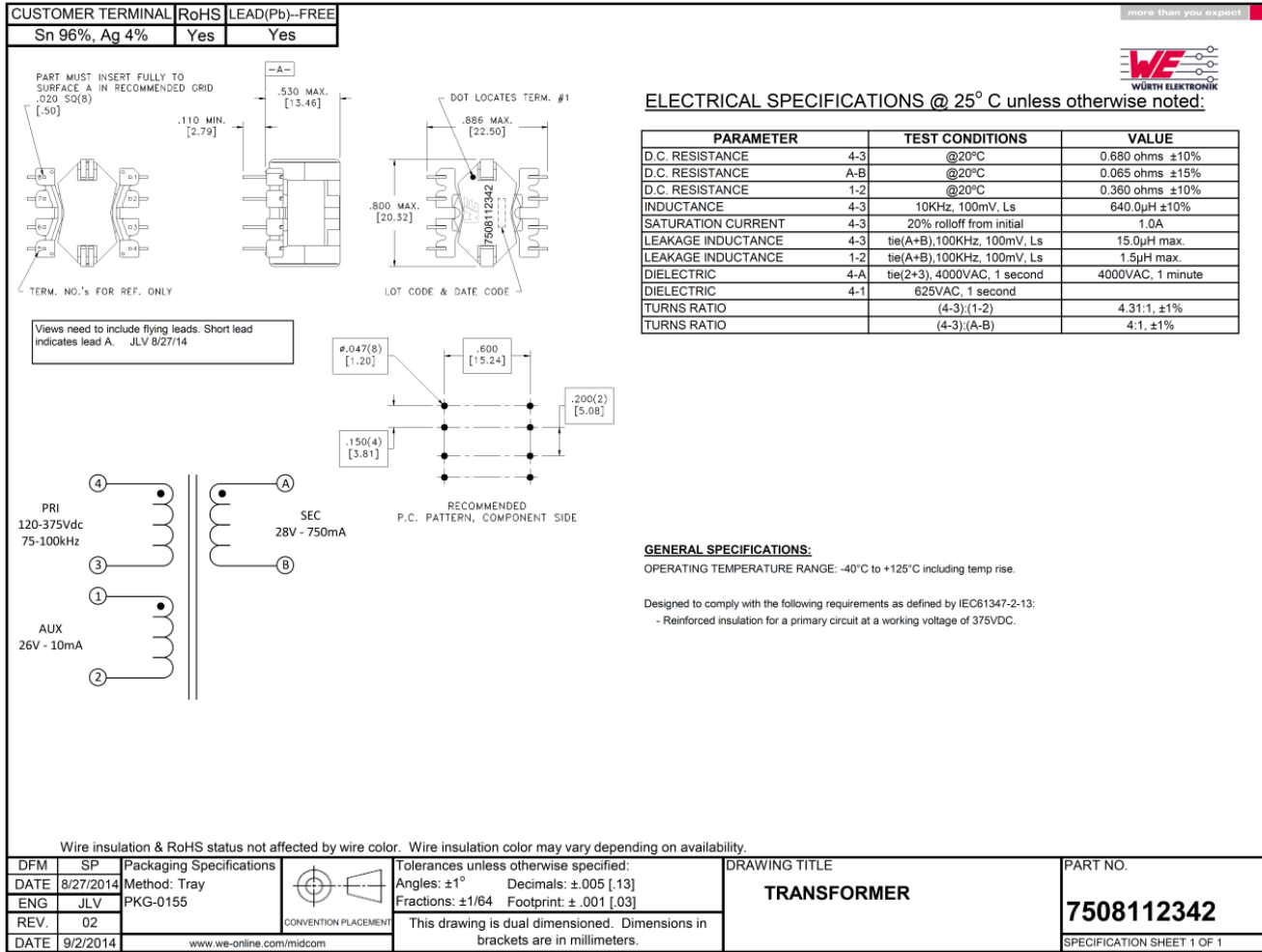
CIRCUIT BOARD FABRICATION NOTES

1. Fabricate per IPC-6011 and IPC6012. Inspect to IPA-A-600 Class 2 or updated standard.
2. Printed Circuit Board is defined by files listed in fileset.
3. Modification to copper within the PCB outline is not allowed without permission, except where noted otherwise. The manufacturer may make adjustments to compensate for manufacturing process, but the final PCB is required to reflect the associated gerber file design  $\pm 0.001$  in. for etched features within the PCB outline.
4. Material in accordance with IPC-4101/21, FR4, Tg 125°C min.
5. Layer to layer registration shall not exceed  $\pm 0.004$  in.
6. External finished copper conductor thickness shall be 0.0026 in. min. (ie 2oz)
7. Copper plating thickness for through holes shall be 0.0013 in. min. (ie 1oz)
8. All holes sizes are finished hole size.
9. Finished PCB thickness 0.031 in.
10. All un-dimensioned holes to be drilled using the NC drill data.
11. Size tolerance of plated holes:  $\pm 0.003$  in. : non-plated holes  $\pm 0.002$  in.
12. All holes shall be  $\pm 0.003$  in. of their true position U.D.S.
13. Construction to be SMOBC, using liquid photo image (LPI) solder mask in accordance with IPC-SM-B40C, Type B, Class 2, and be green in color.
14. Solder mask mis-registration  $\pm 0.004$  in. max.
15. Silkscreen shall be permanent non-conductive white ink.
16. The fabrication process shall be UL approved and the PCB shall have a flammability rating of UL94V0 to be marked on the solder side in silkscreen with date, manufactures approved logo, and type designation.
17. Warp and twist of the PCB shall not exceed 0.0075 in. per in.
18. 100% electrical verification required.
19. Surface finish: electroless nickel immersion gold (ENIG)
20. RoHS 2002/95/EC compliance required.



# NCL30088FLYGEVB

## FLYBACK TRANSFORMER SPECIFICATION



# NCL30088FLYGEVB

## ECA PICTURES

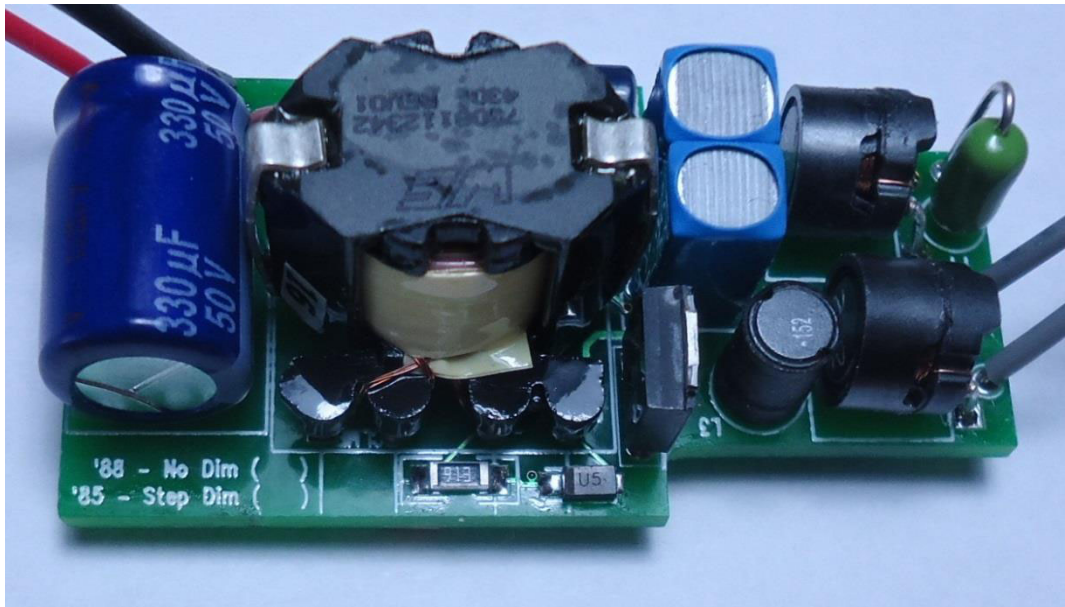


Figure 8. Top View

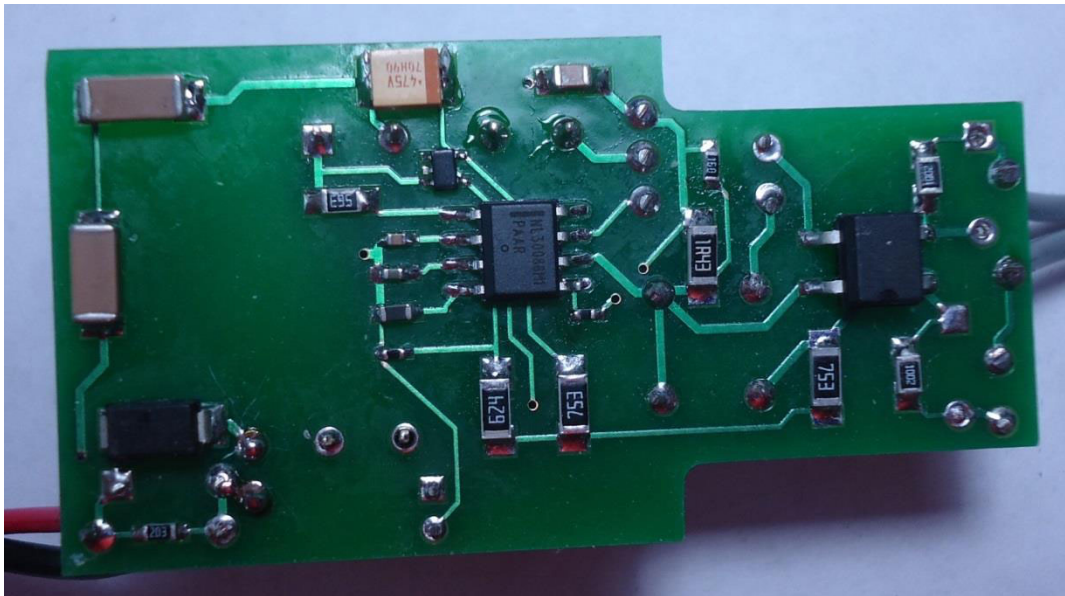


Figure 9. Bottom View

## TEST PROCEDURE

### Equipment Needed

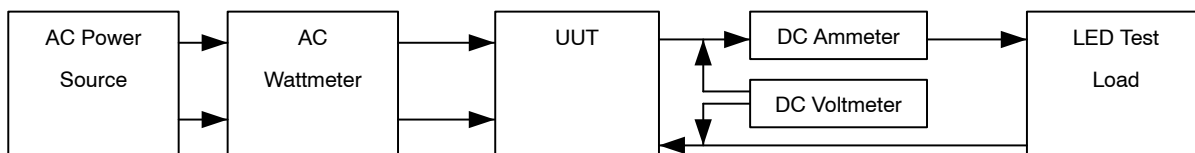
- AC Source – 90 to 305 V ac 50/60 Hz Minimum 500 W capability
- AC Wattmeter – 300 W Minimum, True RMS Input Voltage, Current, Power Factor, and THD 0.2% accuracy or better
- DC Voltmeter – 300 V dc minimum 0.1% accuracy or better
- DC Ammeter – 1 A dc minimum 0.1% accuracy or better
- LED Load – 10 V – 30 V @ 1 A

### Test Connections

1. Connect the LED Load to the red (+) and black (–) leads through the ammeter shown in Figure 10.

**CAUTION:** Observe the correct polarity or the load may be damaged.

2. Connect the AC power to the input of the AC wattmeter shown in Figure 10. Connect the white leads to the output of the AC wattmeter
3. Connect the DC voltmeter as shown in Figure 10.



NOTE: Unless otherwise specified, all voltage measurements are taken at the terminals of the UUT.

**Figure 10. Test Set Up**

### Functional Test Procedure

1. Set the LED Load for 26 V output.
2. Set the input power to 120 V 60 Hz.

**CAUTION:** Do not touch the ECA once it is energized because there are hazardous voltages present.

## LINE AND LOAD REGULATION

**Table 3. 120 V / MAX LOAD**

|      | Output Current<br>350 mA ± 14 mA | Output Power | Power Factor | THD < 20% |
|------|----------------------------------|--------------|--------------|-----------|
| 14 V |                                  |              |              |           |
| 21 V |                                  |              |              |           |
| 28 V |                                  |              |              |           |

**Table 4. 230 V / MAX LOAD**

|      | Output Current<br>350 mA ± 14 mA | Output Power | Power Factor | THD < 30% |
|------|----------------------------------|--------------|--------------|-----------|
| 14 V |                                  |              |              |           |
| 21 V |                                  |              |              |           |
| 28 V |                                  |              |              |           |

$$\text{Efficiency} = \frac{V_{\text{out}} \times I_{\text{out}}}{P_{\text{in}}} \times 100\%$$

# NCL30088FLYGEVB

## TEST DATA

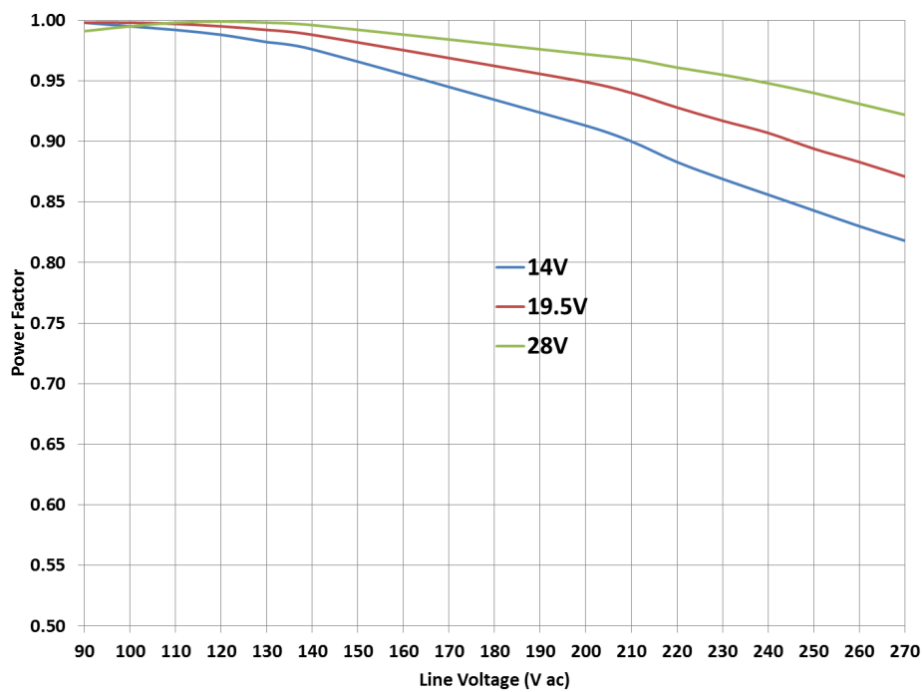


Figure 11. Power Factor over Line and Load

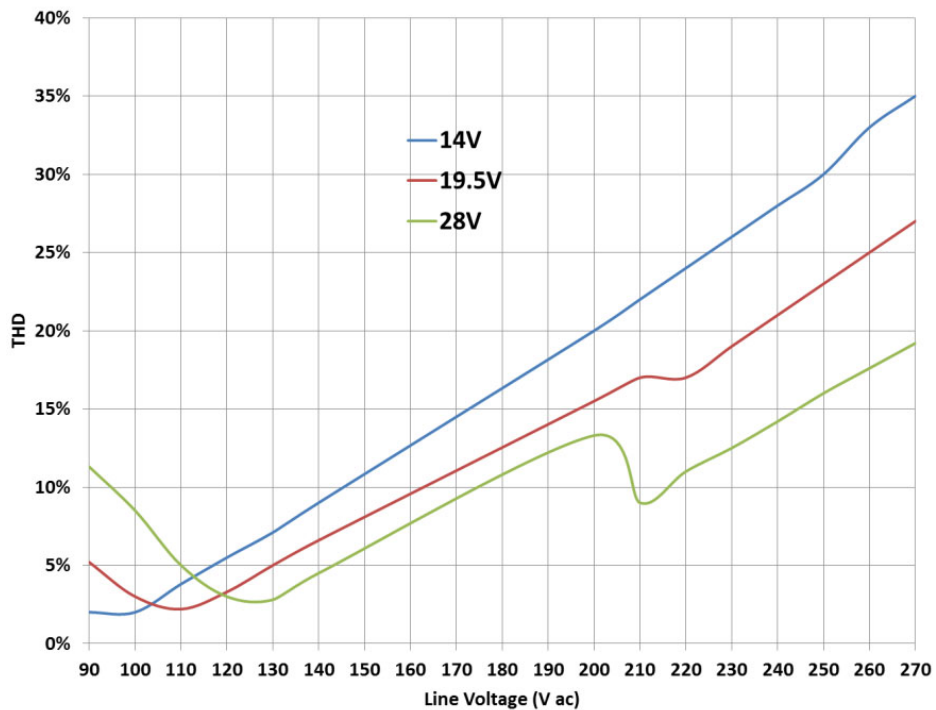


Figure 12. THD over Line and Load

# NCL30088FLYGEVB

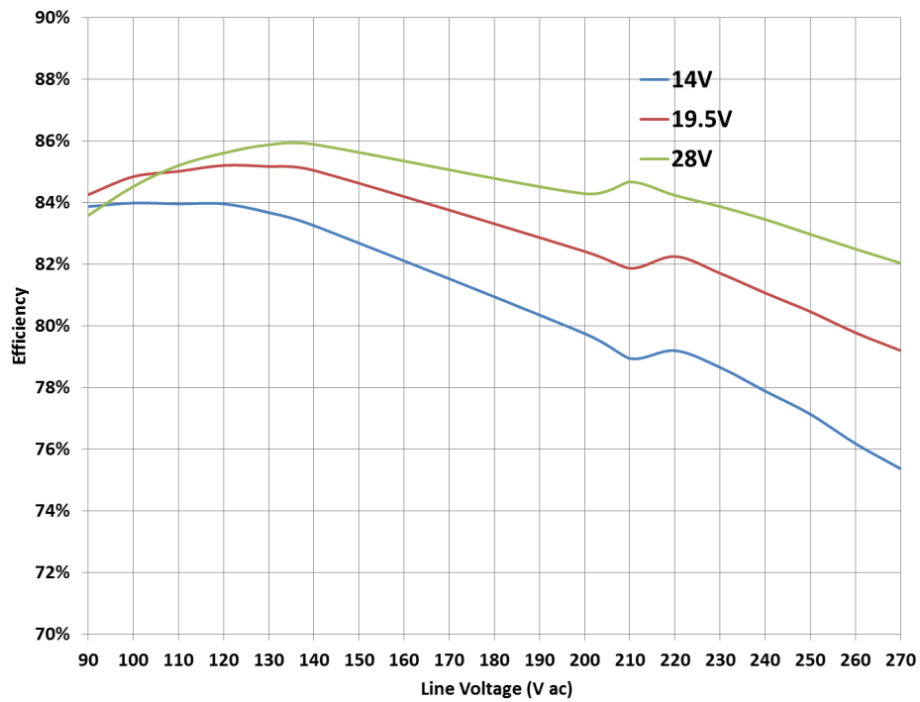


Figure 13. Efficiency over Line and Load at Maximum Output Current

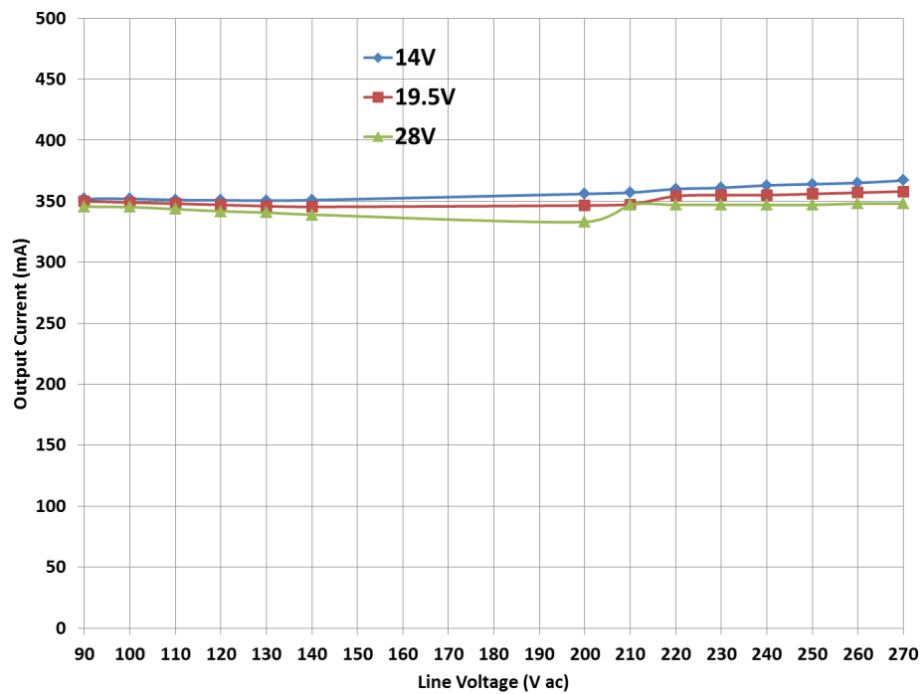


Figure 14. Maximum Current Load Regulation over Line

## NCL30088FLYGEVB

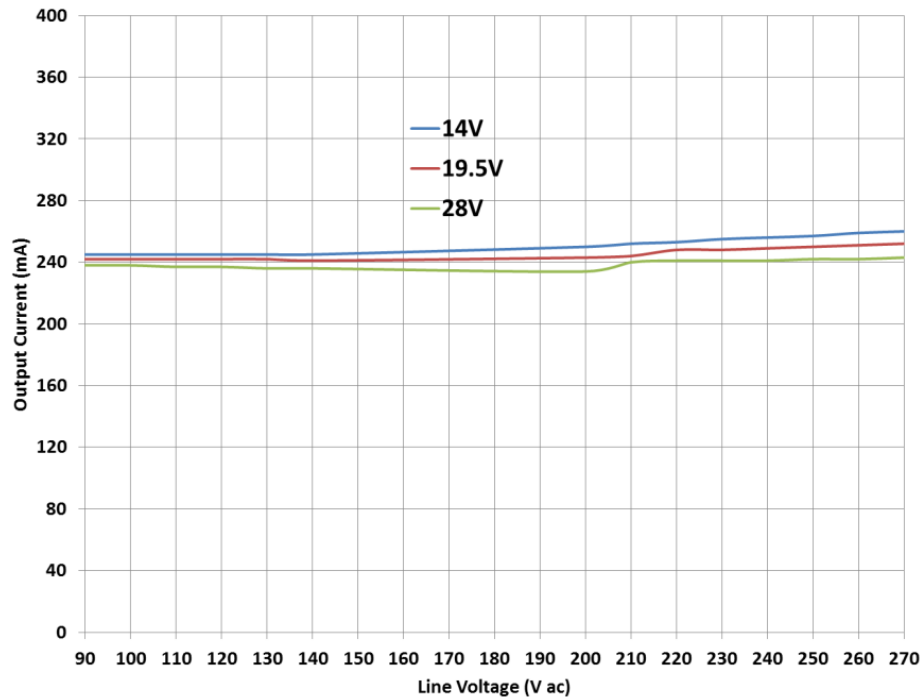


Figure 15. 70% Load Regulation over Line (NCL30085FLYG only)

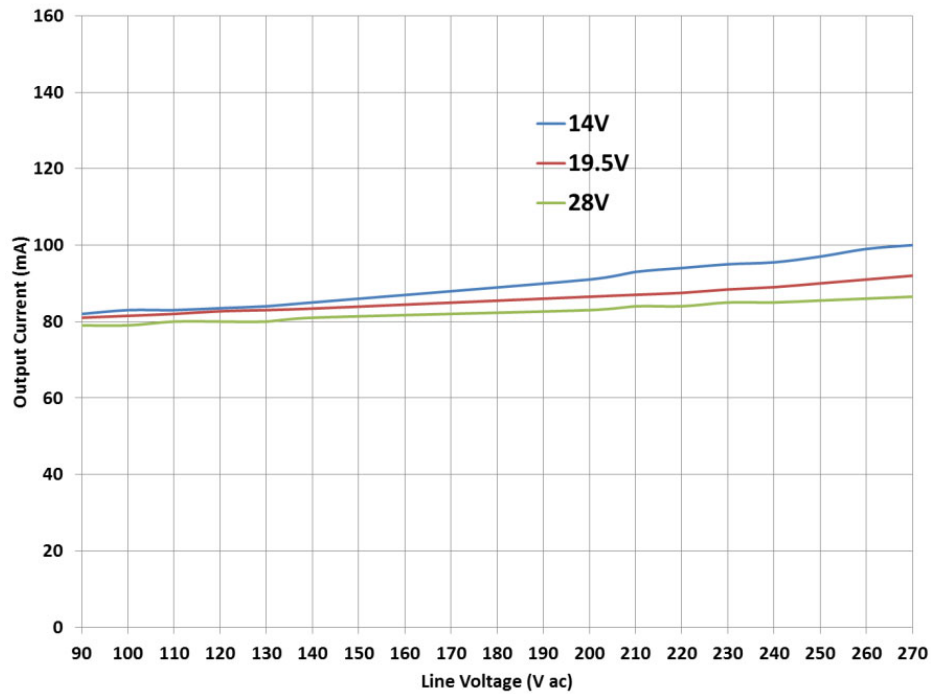


Figure 16. 25% Load Regulation over Line (NCL30085FLYG only)

# NCL30088FLYGEVB

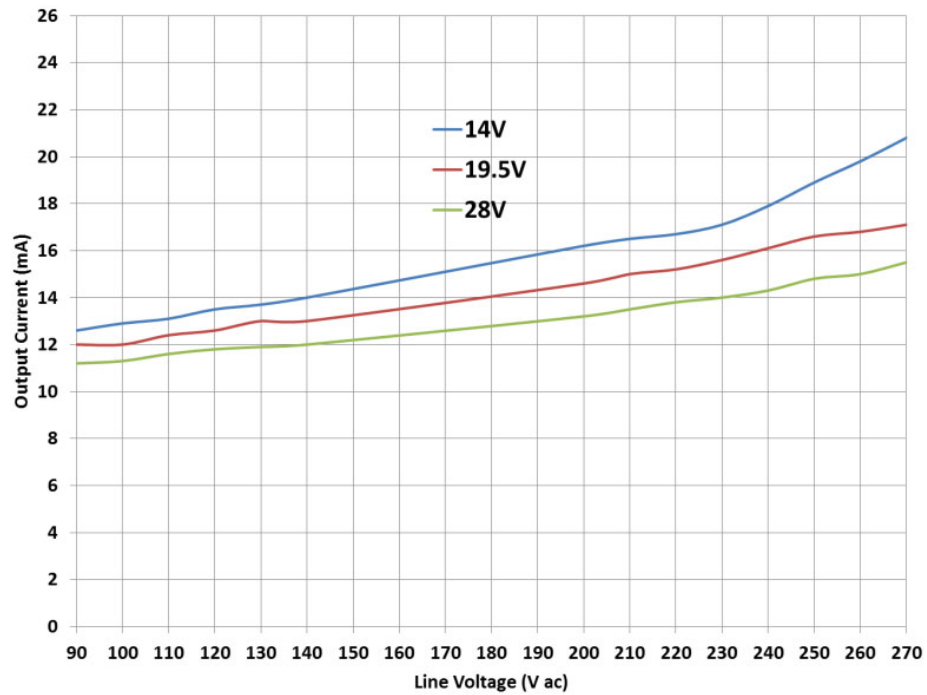


Figure 17. Minimum Load Regulation over Line (NCL30085FLYG only)

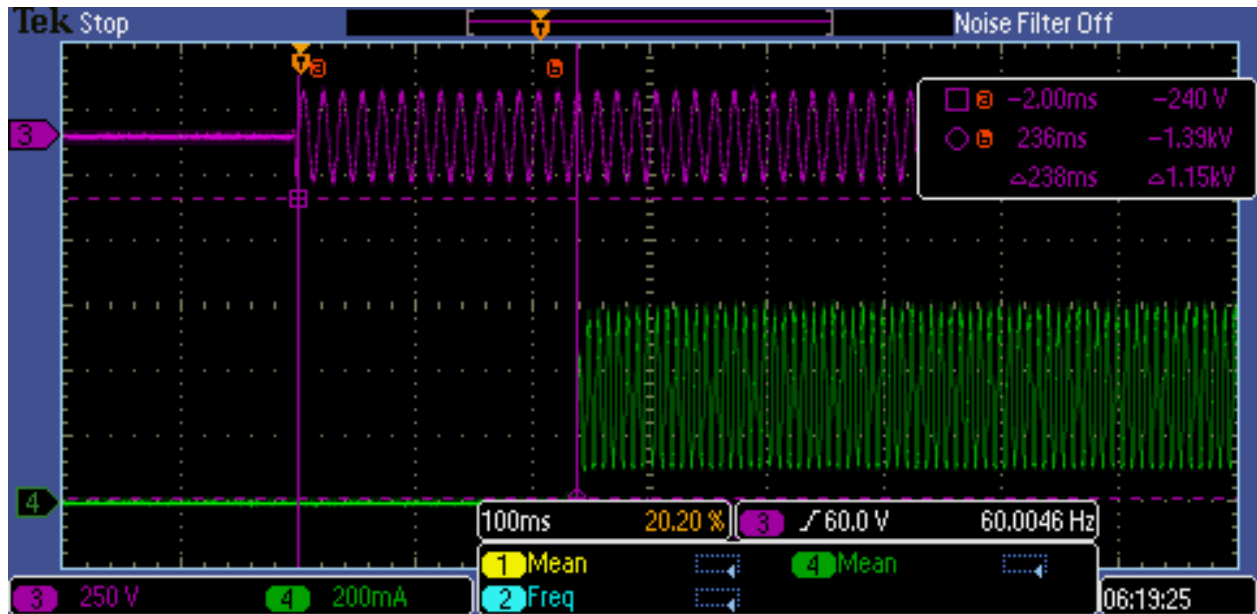


Figure 18. Start Up with AC Applied 120 V Maximum Load

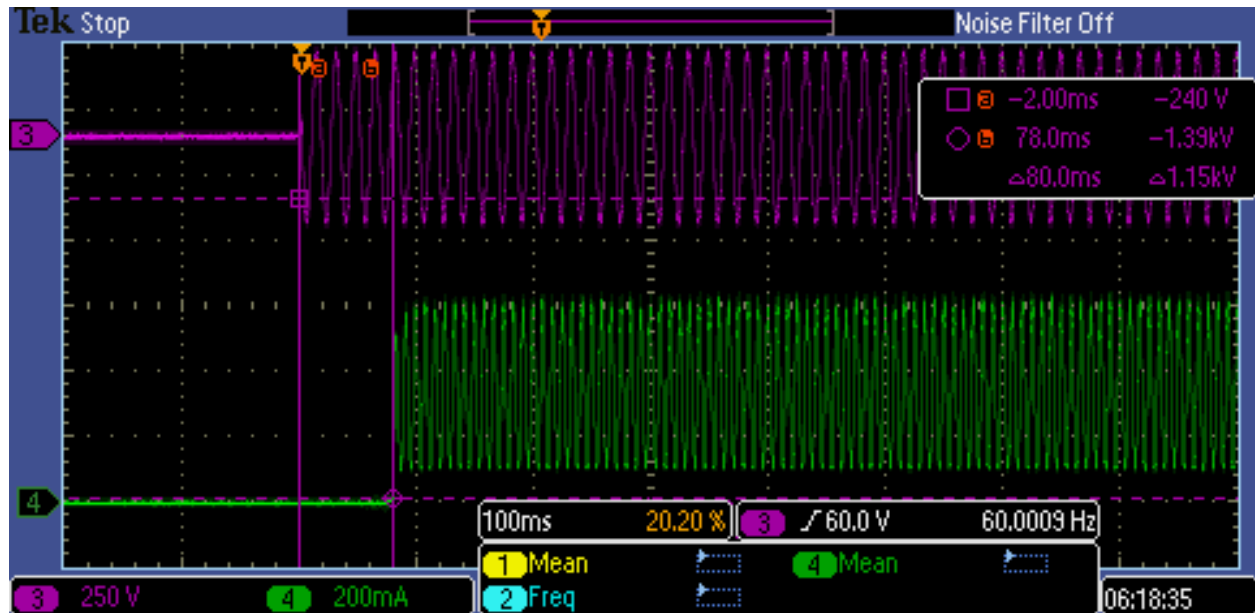


Figure 19. Start Up with AC Applied 230 V Maximum Load

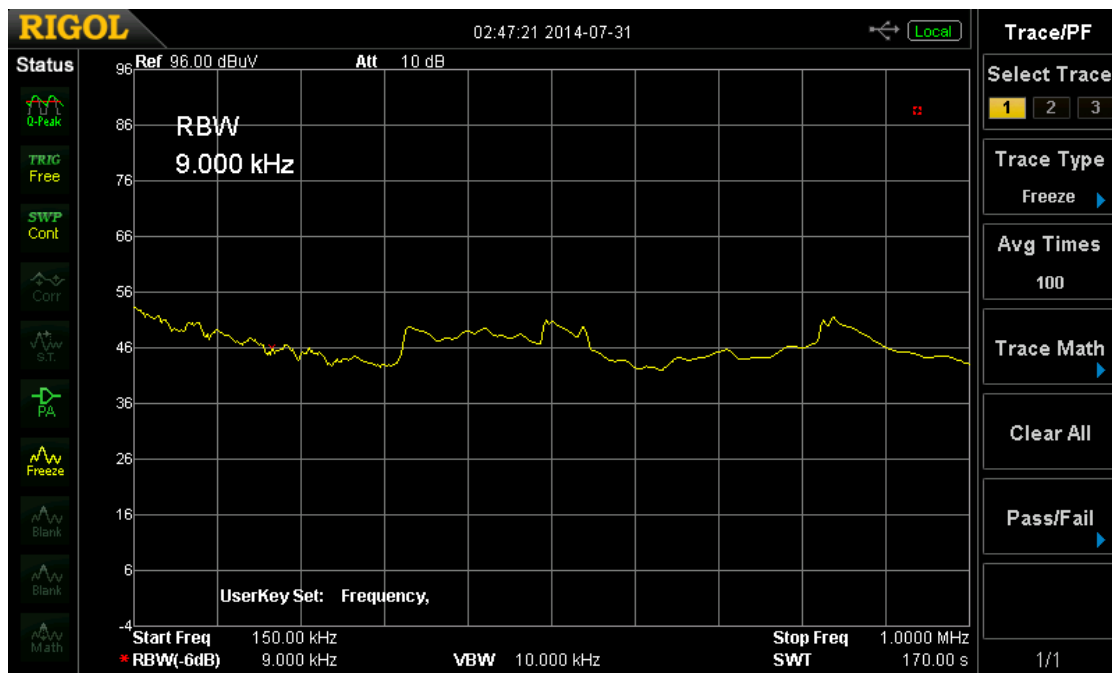


Figure 20. Conducted EMI Pre-compliance QP Data 150 kHz – 1 MHz



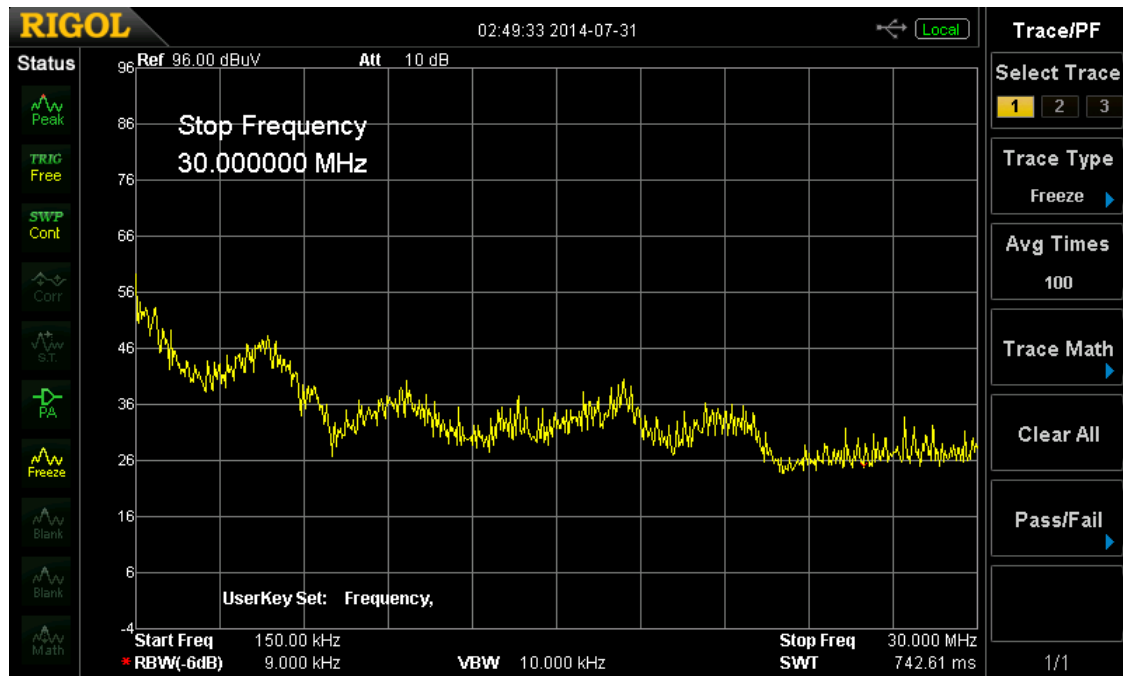


Figure 21. Conducted EMI Pre-compliance Peak Data 150 kHz – 30 MHz

**onsemi**, **onsemi**, and other names, marks, and brands are registered and/or common law trademarks of Semiconductor Components Industries, LLC dba "**onsemi**" or its affiliates and/or subsidiaries in the United States and/or other countries. **onsemi** owns the rights to a number of patents, trademarks, copyrights, trade secrets, and other intellectual property. A listing of **onsemi**'s product/patent coverage may be accessed at [www.onsemi.com/site/pdf/Patent-Marking.pdf](http://www.onsemi.com/site/pdf/Patent-Marking.pdf). **onsemi** is an Equal Opportunity/Affirmative Action Employer. This literature is subject to all applicable copyright laws and is not for resale in any manner.

The evaluation board/kit (research and development board/kit) (hereinafter the "board") is not a finished product and is not available for sale to consumers. The board is only intended for research, development, demonstration and evaluation purposes and will only be used in laboratory/development areas by persons with an engineering/technical training and familiar with the risks associated with handling electrical/mechanical components, systems and subsystems. This person assumes full responsibility/liability for proper and safe handling. Any other use, resale or redistribution for any other purpose is strictly prohibited.

**THE BOARD IS PROVIDED BY ONSEMI TO YOU "AS IS" AND WITHOUT ANY REPRESENTATIONS OR WARRANTIES WHATSOEVER. WITHOUT LIMITING THE FOREGOING, ONSEMI (AND ITS LICENSORS/SUPPLIERS) HEREBY DISCLAIMS ANY AND ALL REPRESENTATIONS AND WARRANTIES IN RELATION TO THE BOARD, ANY MODIFICATIONS, OR THIS AGREEMENT, WHETHER EXPRESS, IMPLIED, STATUTORY OR OTHERWISE, INCLUDING WITHOUT LIMITATION ANY AND ALL REPRESENTATIONS AND WARRANTIES OF MERCHANTABILITY, FITNESS FOR A PARTICULAR PURPOSE, TITLE, NON-INFRINGEMENT, AND THOSE ARISING FROM A COURSE OF DEALING, TRADE USAGE, TRADE CUSTOM OR TRADE PRACTICE.**

**onsemi** reserves the right to make changes without further notice to any board.

You are responsible for determining whether the board will be suitable for your intended use or application or will achieve your intended results. Prior to using or distributing any systems that have been evaluated, designed or tested using the board, you agree to test and validate your design to confirm the functionality for your application. Any technical, applications or design information or advice, quality characterization, reliability data or other services provided by **onsemi** shall not constitute any representation or warranty by **onsemi**, and no additional obligations or liabilities shall arise from **onsemi** having provided such information or services.

**onsemi** products including the boards are not designed, intended, or authorized for use in life support systems, or any FDA Class 3 medical devices or medical devices with a similar or equivalent classification in a foreign jurisdiction, or any devices intended for implantation in the human body. You agree to indemnify, defend and hold harmless **onsemi**, its directors, officers, employees, representatives, agents, subsidiaries, affiliates, distributors, and assigns, against any and all liabilities, losses, costs, damages, judgments, and expenses, arising out of any claim, demand, investigation, lawsuit, regulatory action or cause of action arising out of or associated with any unauthorized use, even if such claim alleges that **onsemi** was negligent regarding the design or manufacture of any products and/or the board.

This evaluation board/kit does not fall within the scope of the European Union directives regarding electromagnetic compatibility, restricted substances (RoHS), recycling (WEEE), FCC, CE or UL, and may not meet the technical requirements of these or other related directives.

**FCC WARNING** – This evaluation board/kit is intended for use for engineering development, demonstration, or evaluation purposes only and is not considered by **onsemi** to be a finished end product fit for general consumer use. It may generate, use, or radiate radio frequency energy and has not been tested for compliance with the limits of computing devices pursuant to part 15 of FCC rules, which are designed to provide reasonable protection against radio frequency interference. Operation of this equipment may cause interference with radio communications, in which case the user shall be responsible, at its expense, to take whatever measures may be required to correct this interference.

**onsemi** does not convey any license under its patent rights nor the rights of others.

**LIMITATIONS OF LIABILITY:** **onsemi** shall not be liable for any special, consequential, incidental, indirect or punitive damages, including, but not limited to the costs of requalification, delay, loss of profits or goodwill, arising out of or in connection with the board, even if **onsemi** is advised of the possibility of such damages. In no event shall **onsemi**'s aggregate liability from any obligation arising out of or in connection with the board, under any theory of liability, exceed the purchase price paid for the board, if any.

The board is provided to you subject to the license and other terms per **onsemi**'s standard terms and conditions of sale. For more information and documentation, please visit [www.onsemi.com](http://www.onsemi.com).

## ADDITIONAL INFORMATION

### TECHNICAL PUBLICATIONS:

Technical Library: [www.onsemi.com/design/resources/technical-documentation](http://www.onsemi.com/design/resources/technical-documentation)  
onsemi Website: [www.onsemi.com](http://www.onsemi.com)

ONLINE SUPPORT: [www.onsemi.com/support](http://www.onsemi.com/support)

For additional information, please contact your local Sales Representative at [www.onsemi.com/support/sales](http://www.onsemi.com/support/sales)